



STP9547 Pb
Lead-free

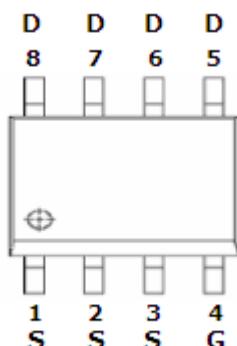
P Channel Enhancement Mode MOSFET

- 6.8A

DESCRIPTION

The STP9547 is the P-Channel logic enhancement mode power field effect transistor is produced using high cell density, DMOS trench technology. This high density process is especially tailored to minimize on-state resistance. These devices are particularly suited for low voltage application such as cellular phone and notebook computer power management and other batter powered circuits where high-side switching.

PIN CONFIGURATION SOP-8



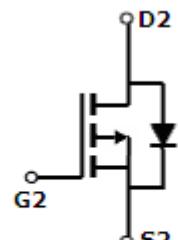
FEATURE

- -40V/-5.6A, $R_{DS(ON)} = 55m\Omega$ @ $V_{GS} = -10V$
- -40V/-5.2A, $R_{DS(ON)} = 80m\Omega$ @ $V_{GS} = -4.5V$
- Super high density cell design for extremely low $R_{DS(ON)}$
- Exceptional on-resistance and maximum DC current capability
- SOP-8 package design

PART MARKING SOP-8



S : Subcontractor Y : Year Code
A : Process Code



P-Channel

ORDERING INFORMATION

Part Number	Package	Part Marking
STP9547S8RG	SOP-8P	STP9547
STP9547S8TG	SOP-8P	STP9547

* Process Code : A ~ Z ; a ~ z

* STP9547S8RG S8 : SOP-8 ; R : Tape Reel ; G : Pb – Free

* STP9547S8TG S8 : SOP-8 ; T : Tube ; G : Pb – Free



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ABSOULTE MAXIMUM RATINGS (Ta = 25°C unless otherwise noted)

Parameter	Symbol	Typical	Unit	
Drain-Source Voltage	VDSS	-40	V	
Gate-Source Voltage	VGSS	±20	V	
Continuous Drain Current (TJ=150°C)	TA=25°C TA=70°C	ID	-6.8 -5.2	A
Pulsed Drain Current	IDM	-30	A	
Continuous Source Current (Diode Conduction)	IS	-2.3	A	
Power Dissipation	TA=25°C TA=70°C	PD	2.5 1.6	W
Operation Junction Temperature	TJ	150	°C	
Storage Temperature Range	TSTG	-55/150	°C	
Thermal Resistance-Junction to Ambient	R _{θJA}	70	°C/W	



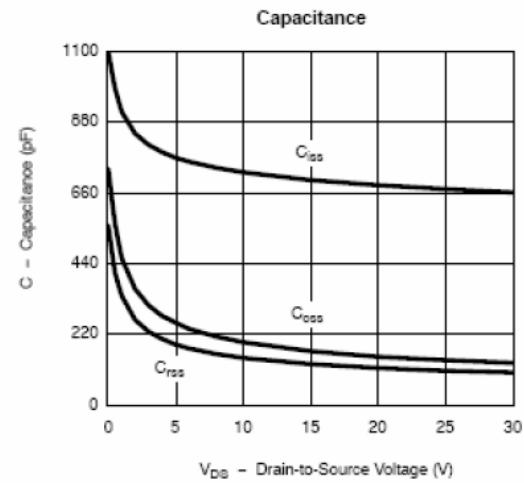
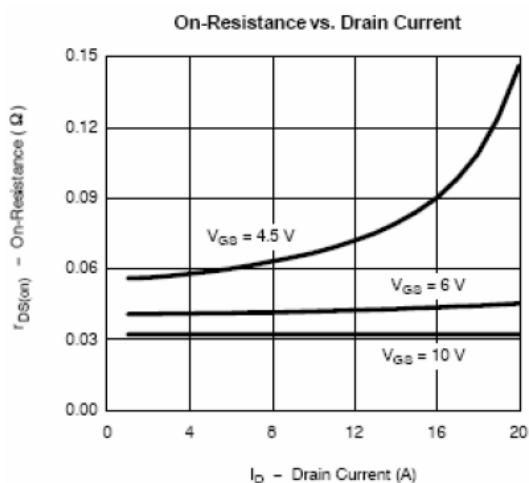
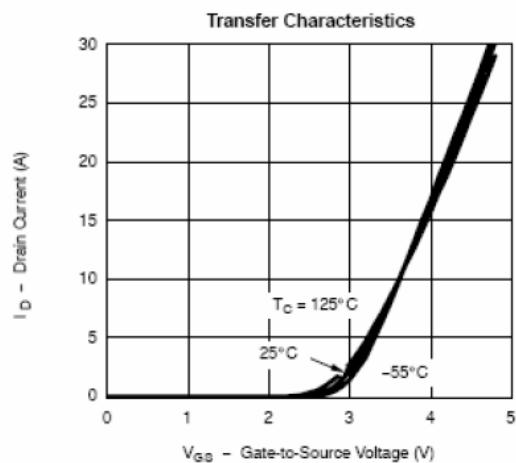
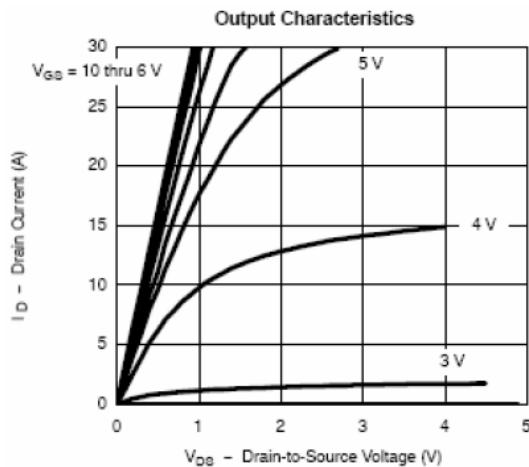
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ELECTRICAL CHARACTERISTICS (Ta = 25°C unless otherwise noted)

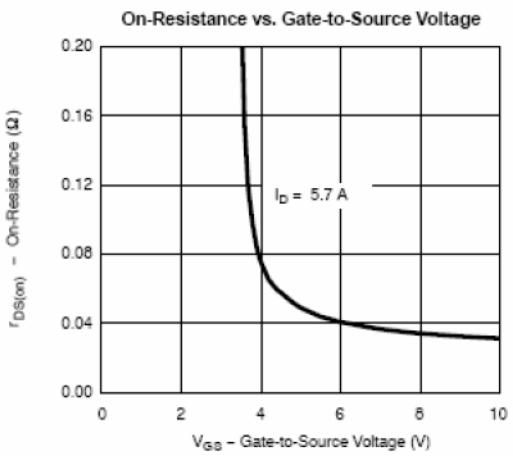
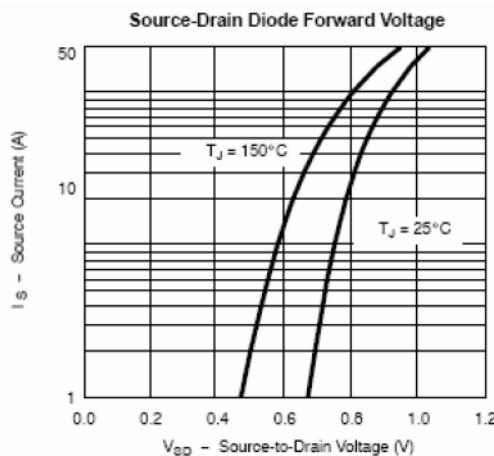
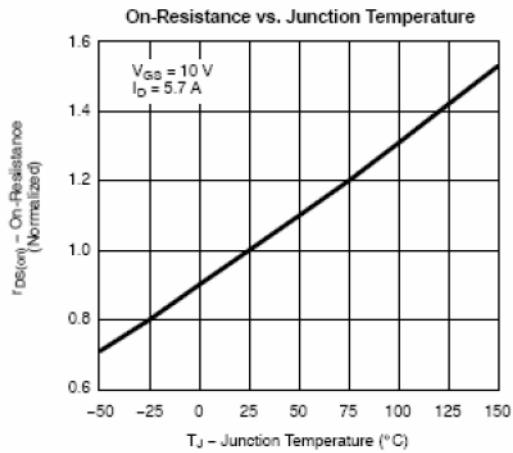
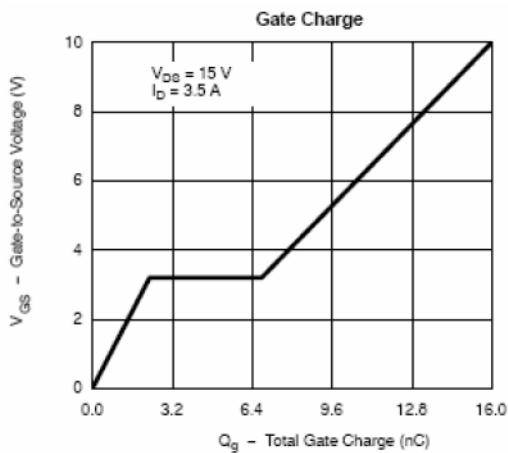
Parameter	Symbol	Condition	Min	Typ	Max	Unit
Static						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} =0V, ID=-250uA	-40			V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , ID=-250uA	-1.0		-3.0	V
Gate Leakage Current	I _{GSS}	V _{DS} =0V, V _{GS} =±20V			±100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-24V, V _{GS} =0V			-1	uA
		V _{DS} =-24V, V _{GS} =0V T _J =85°C			-5	
On-State Drain Current	I _{D(on)}	V _{DS} =-5V, V _{GS} =-4.5V	-10			A
Drain-source On-Resistance	R _{D(on)}	V _{GS} =-10V, ID=-5.6A V _{GS} =-4.5V, ID=-5.2A	47 62	60 80		mΩ
Forward Transconductance	g _f	V _{DS} =-15V, ID=-5.6V		13		S
Diode Forward Voltage	V _{SD}	I _s =-2.3A, V _{GS} =0V		-0.8	-1.2	V
Dynamic						
Total Gate Charge	Q _g	V _{DS} =-15V, V _{GS} =-10V I _D =-3.5A		16	24	nC
Gate-Source Charge	Q _{gs}			2.3		
Gate-Drain Charge	Q _{gd}			4.5		
Input Capacitance	C _{iss}	V _{DS} = -15V, V _{GS} =0V f=1MHz		680		pF
Output Capacitance	C _{oss}			120		
Reverse TransferCapacitance	C _{rss}			75		
Turn-On Time	t _{d(on)} tr	V _{DD} =-15V, R _L =15Ω I _D =-1A, V _{GEN} =-10V R _G =6Ω		14	25	nS
				16	26	
Turn-Off Time	t _{d(off)} tf			43	70	
				30	52	

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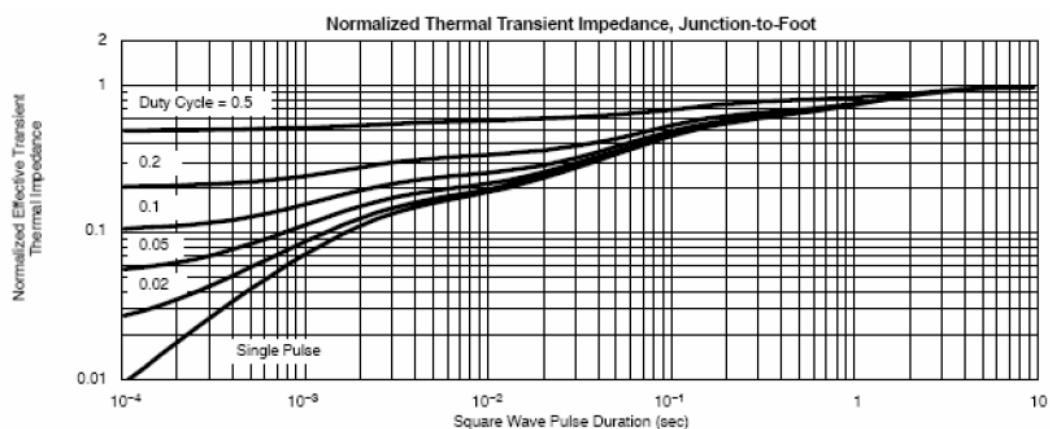
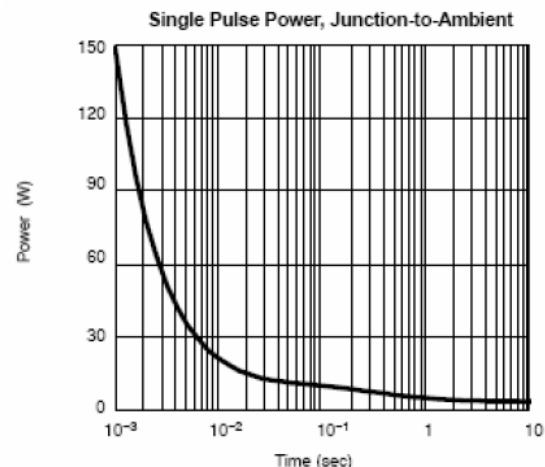
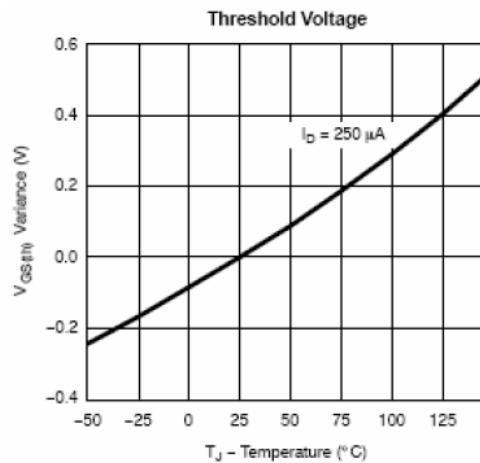
TYPICAL CHARACTERISTICS



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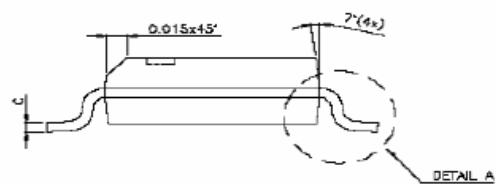
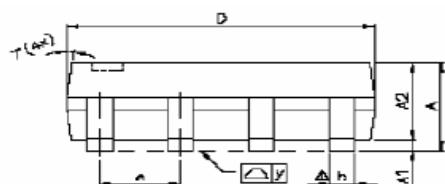
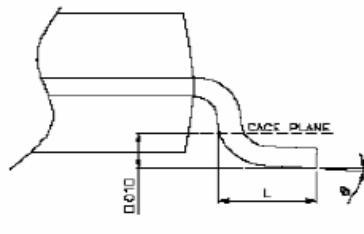
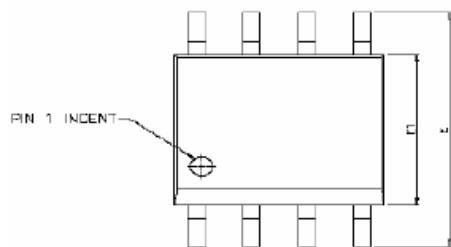




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PACKAGE OUTLINE SOP-8P



SYMBOLS	DIMENSIONS IN MILLIMETERS			DIMENSIONS IN INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	1.47	1.60	1.73	0.058	0.063	0.068
A1	0.10	—	0.25	0.004	—	0.010
A2	—	1.45	—	—	0.057	—
b	0.33	0.41	0.51	0.013	0.016	0.020
C	0.19	0.20	0.25	0.0075	0.008	0.0098
D	4.80	4.85	4.95	0.189	0.191	0.195
E	5.80	6.00	6.20	0.228	0.236	0.244
E1	3.80	3.90	4.00	0.150	0.154	0.157
e	—	1.27	—	—	0.050	—
L	0.38	0.71	1.27	0.015	0.028	0.050
△y	—	—	0.076	—	—	0.003
θ	0°	—	8°	0°	—	8°